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H8/300L Super Low Power Series

Conversion from 2-Byte Hexadecimal to 5-Digit Decimal Number (HEX)

Introduction

The software HEX converts a 2-byte hexadecimal number, which is placed in a general-purpose register, to a 5-digit BCD (binary-coded decimal) number and places the result in general-purpose registers.

Target Device

H8/38024

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1. Arguments

Description	n	Memory area	Data length (bytes)
Input	2-byte hexadecimal number	R0	2
Output	5-digit BCD number (upper 1 digit)	R2L	1
	5-digit BCD number (lower 4 digits)	R3	2

2. Changes to Internal Registers and Flags

R0	R1	R2H	R2L	R3	R4	R5	R6	R7
×	_	×	0	0	_	_	_	
						_	.,	
	U	Н	U		N	Z	V	C
		×	_		×	×	×	×

Legend

—: No change

×: Undefined

o: Result

3. Specifications

г	
	Program memory (bytes)
	30
	Data memory (bytes)
	0
	Stack (bytes)
Ī	0
Ī	Clock cycle count
	368
	Reentrant
	Possible
	Relocation
	Possible
	Interrupt
	Possible



4. Description

4.1 Details of functions

- 1. The following arguments are used with the software HEX:
 - R0: Sets a 2-byte hexadecimal number as an input argument.
 - R2L: The upper 1 digit (1 byte) of the 5-digit BCD number is placed here as an output argument.
 - R3: The lower 4 digits (2 bytes) of the 5-digit BCD number are placed here as an output argument.

Figure 1 shows the formats of the input and output arguments.

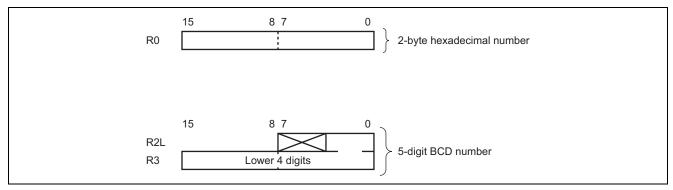


Figure 1 Formats of Input and Output Arguments

2. The following figure illustrates the execution of the software HEX. When the input argument is set as shown in (1), the 5-digit BCD number is placed in R2L and R3 as shown in (2).

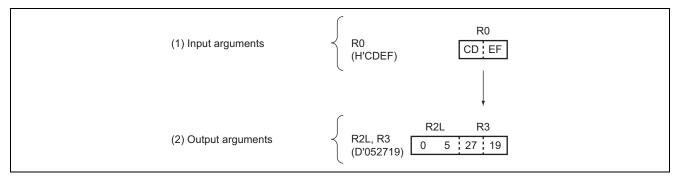


Figure 2 Example of Software HEX Execution



4.2 Note on usage

When upper bits are not used (see figure 3), set them to 0; otherwise, a correct result cannot be obtained because computation is made on numbers including indeterminate data placed in the upper bits.

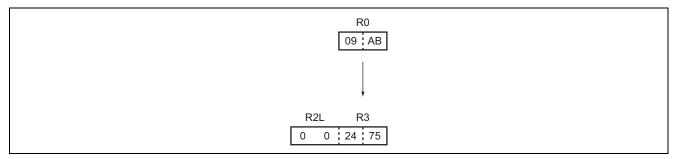


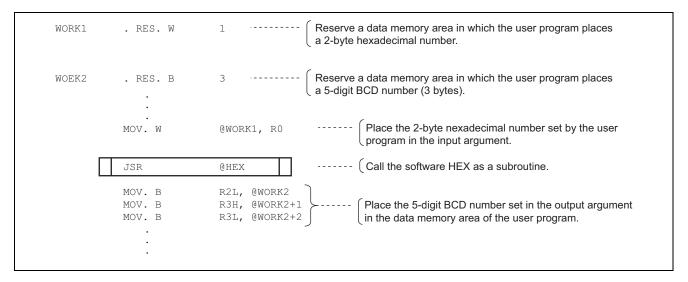
Figure 3 Examples of Operation with Upper Bits Unused

4.3 Description of data memory

The software HEX does not use the data memory.

4.4 Example of usage

Set a 2-byte hexadecimal number in R0 and call the software HEX as a subroutine.





4.5 Operation

1. A 4-bit binary number "B₃B₂B₁B₀" is represented by equations 1 and 2 below:

```
B_{3} \ B_{2} \ B_{1} \ B_{0} = B_{3} \times 2^{3} + B_{2} \times 2^{2} + B_{1} \times 2^{1} + B_{0} \times 2^{0} - ---- - \text{(equation 1)}
= ((B_{3} \times 2 + B_{2}) \times 2 + B_{1}) \times 2 + B_{0} - ---- - \text{(equation 2)}
```

Figure 4 4-bit Binary Number "B₃B₂B₁B₀"

- 2. First, equation 2 is used to compute $\alpha = B_3 \times 2 + B_2$ (see figure 4) by executing an add instruction (ADD.B) and decimal adjust instruction (DAA). Next, a series of operations, $\beta = \alpha \times 2 + B_1$, $\gamma = \beta \times 2 + B_0$, etc. are performed to produce a 5-digit BCD number as the result.
- 3. The software HEX uses R0 and R2L and R3 to compute $\alpha = B_3 \times 2 + B_2$.
 - a. R2H is used as the counter that counts the number of bit shifts on R0, which contains the input argument. D'16 is set in R2H for a total of 16 shifts.
 - b. R0 containing the 2-byte hexadecimal number is shifted 1 bit to left, and the most significant bit is thus loaded to the C bit.
 - c. R2L and R3 containing the 5-digit BCD number are processed in lowest byte-to-highest byte order, as follows:

R3L + R3L + C \rightarrow R3L; R3L is then decimal-adjusted.

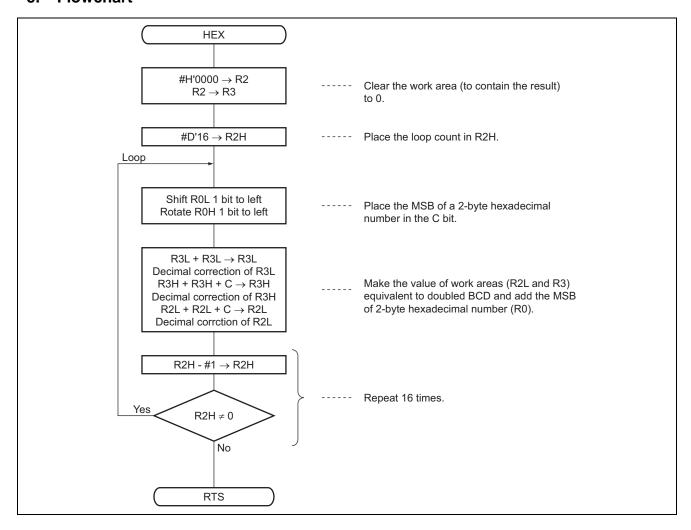
R3H + R3H + C \rightarrow R3H; R3H is then decimal-adjusted. R2L + R2L + C \rightarrow R2L; R2L is then decimal-adjusted.

Thus, $\alpha = B_3 \times 2 + B_2$ is computed.

d. In the software HEX, R2H is decremented each time steps b and c are performed. This processing is repeated until R2H reaches "0".



5. Flowchart





6. Program List

```
*** H8/300 ASSEMBLER VER 1.0B ** 08/18/92 10:24:23
PROGRAM NAME =
                           ; *
                                00 - NAME
3
                                                         :CHANGE 2 BYTE HEXADECIMAL
                           ; *
                                                   TO BCD (HEX)
                           ; *****************
                               ENTRY
                                                  :R0 (HEXADECIMAL)
                          ; *
9
10
                           ; *
                                RETURNS : R2L (UPPER 1 CHARACTER (BY BCD))
                           ; *
11
                                                  R3 (LOWER 4 CHARACTER (BY BCD))
                           ; *
12
                           13
14
15 HEX_code C
             0000
                                .SECTION
                                                  HEX_code, CODE, ALIGN=2
                                .EXPORT HEX
16
              00000000 HEX .EQU $
18 HEX_code C
                                                  ;Entry point
19 HEX_code C 0000 79020000
                                MOV.W #H'0000,R2 ;Clear R2
20 HEX_code C 0004 0D23
                                MOV.W R2,R3
                                                  ;Clear R3
21 HEX_code C 0006 F210
                                MOV.B #D'16,R2H
                                                  ;Set bit counter
22 HEX_code C 0008
                         LOOP
23 HEX_code C 0008 1008
                                SHLL.B ROL
                                                  ;Shift hexadecimal 1 bit left
24 HEX_code C
            000A 1200
                                ROTXL.B ROH
25
26 HEX_code C 000C 0EBB
                                ADDX.B R3L,R3L
                                                 ;R3L + R3L -> R3L
                                DAA R3L
27 HEX_code C 000E 0F0B
                                                 ;Decimal adjust R3L
                                                ;R3H + R3H + C -> R3H
28 HEX_code C 0010 0E33
                                ADDX.B R3H,R3H
                                DAA
29 HEX_code C 0012 0F03
                                      R3H
                                                 ;Decimal adjust R3H
30 HEX_code C 0014 0EAA
                                ADDX.B R2L,R2L
                                                 ;R2L + R2L + C -> R2L
31 HEX_code C 0016 0F0A
                                DAA
                                       R2L
                                                  ;Decimal adjust R2L
32
33 HEX_code C 0018 1A02
                                DEC.B
                                       R2H
                                                 ;Decrement R2H
34 HEX_code C 001A 46EC
                                BNE
                                       LOOP
                                                  ;Branch Z=0
35 HEX_code C 001C 5470
36
                                .END
*****TOTAL ERRORS 0
*****TOTAL WARNINGS 0
```



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